## HIGH-FREQUENCY SWITCH MODULE

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## Abstract of JP2002064401

PROBLEM TO BE SOLVED: To provide a high-frequency switch module which is reduced in insertion loss and improved in receiving sensitivity in receiving. SOLUTION: A high-frequency switch module has a structure in which a first switching element is disposed between a transmission circuit and an antenna, a transmission line is disposed between the antenna and a receiving circuit. the end of the transmission line on the receiving circuit side is grounded through the intermediary of a second switching element, and a filter circuit is arranged between the antenna and the connecting point between the first switching element and the transmission line. The high-frequency switch module switches the signal path of high-frequency signals from one to another by the use of the first and second switching element, and the characteristic impedance of the transmission line is set at 30 to 45 &Omega.